



MJ N-Channel Enhancement Mode Power MOSFET

Description

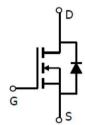
The MJ4012S uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

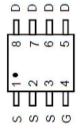
General Features

- $ightharpoonup V_{DS} = 40V, I_D = 12A$ $R_{DS(ON)} < 12mΩ @ V_{GS} = 10V (Typ. 8.4 mΩ)$ $R_{DS(ON)} < 18mΩ @ V_{GS} = 4.5V (Typ. 12.3 mΩ)$
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high E_{AS}
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability

Application

- ◆ Load switching
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply







Schematic diagram

Marking and pin Assignment

SOP-8 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ4012S	MJ4012S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	12	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	8.5	А
Pulsed Drain Current	Ідм	60	А
Maximum Power Dissipation	Po	3	W
Operating Junction and Storage Temperature Range	Тл,Тѕтс	-55 To 150	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note 2) Reja 41.7 °C/W	ence,Junction-to-Ambient (Note 2) ReJA 41.7 °C/W
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Electrical Characteristics (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V,I _D =250µA	40	45	-	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)				•		
Gate Threshold Voltage	V _G S(th)	V _{DS} =V _{GS} ,I _D =250μA	1.2	1.6	2.5	V
	D	V _{GS} =10V, I _D =10A	-	8.4	12	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =4.5V, I _D =8A	_	12.3	18	mΩ
Forward Transconductance	grs	V _{DS} =5V,I _D =10A	-	75	-	S
Dynamic Characteristics (Note 4)	1					
Input Capacitance	Clss		-	1780	-	PF
Output Capacitance	Coss	V _{DS} =20V,V _{GS} =0V F=1.0MHz	-	209	-	PF
Reverse Transfer Capacitance	Crss	-	-	160	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	6.4	-	nS
Turn-on Rise Time	tr	VDD=20V,RL=2Ω	-	17.2	_	nS
Turn-Off Delay Time	t _{d(off)}	$V_{GS}=10V,R_{G}=3\Omega$	-	29.6	-	nS
Turn-Off Fall Time	tr	-	-	16.8	_	nS
Total Gate Charge	Qg		-	30	-	nC
Gate-Source Charge	Qgs	V _{DS} =20V,I _D =10A V _{GS} =10V	-	4.2	-	nC
Gate-Drain Charge	Q _{gd}	-	-	9.5	-	nC
Drain-Source Diode Characteristics					<u> </u>	<u> </u>
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =10A	-	-	1.2	V
Diode Forward Current (Note 2)	ls		_	-	12	А
Reverse Recovery Time	trr	T. 0500 L 101	_	29	_	nS
Reverse Recovery Charge	Qrr	TJ=25°C,IF=10A di/dt= 100A/µs ^(Note 3)		26		nC

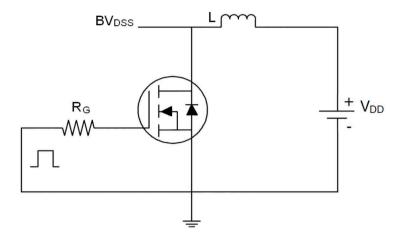
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, $t \le 10$ sec.
- ③ Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production

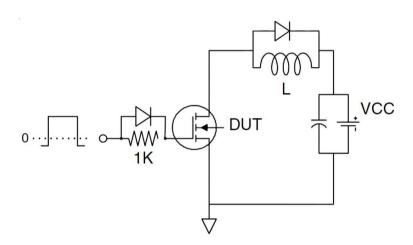




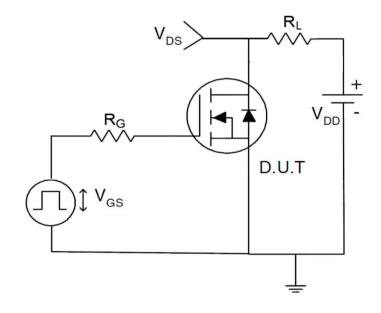
Test circuit



Eas test Circuit



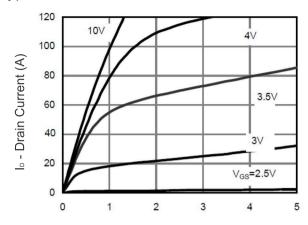
Gate charge test Circuit



Switch Time Test Circuit



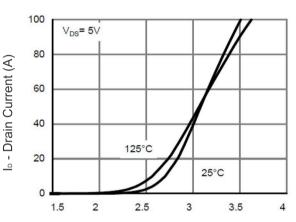
Typical Electrical and Thermal Characteristics (Curves)



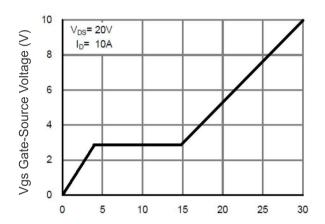
V_{GS}= 10V Normalized On-Resistance I_D= 10A 1.6 1.4 √_{GS}= 4.5∨ ID=8A 1.2 1.0 8.0 0 25 50 75 100 125 150 175

Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

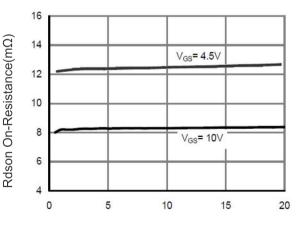


T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature

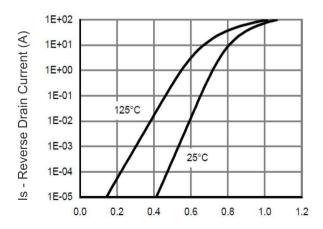


Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics



Qg Gate Charge (nC) Figure 5 Gate Charge



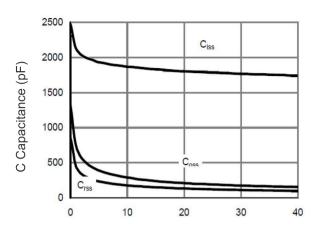
ID - Drain Current (A)

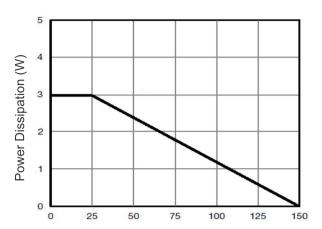
Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward



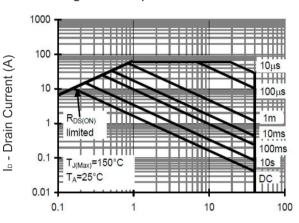




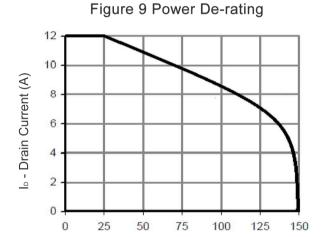


Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



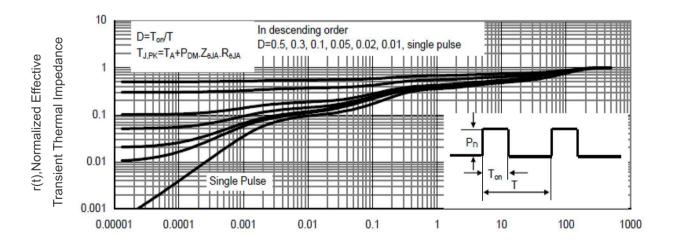
 T_J -Junction Temperature(°C)



Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area

T_J -Junction Temperature(°C)
Figure 10 Current De-rating



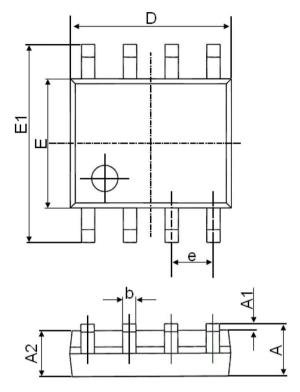
Square Wave Pluse Duration(sec)

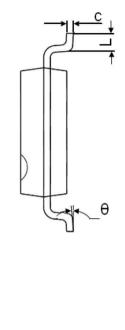
Figure 11 Normalized Maximum Transient Thermal Impedance





SOP-8 Package Information





0	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	





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